

International **IR** Rectifier

PD -91594C

IRG4BC30KD-S

INSULATED GATE BIPOLAR TRANSISTOR WITH
ULTRAFAST SOFT RECOVERY DIODE

Short Circuit Rated
UltraFast IGBT

Features

- High short circuit rating optimized for motor control, $t_{sc} = 10\mu s$, @360V V_{CE} (start), $T_J = 125^\circ C$, $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes

Benefits

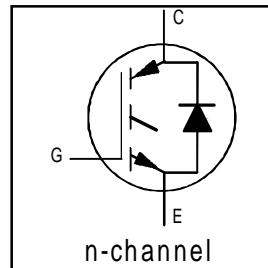
- Latest generation 4 IGBTs offer highest power density motor controls possible
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristic reduce noise, EMI and switching losses
- This part replaces the IRGBC30KD2-S and IRGBC30MD2-S products
- For hints see design tip 97003

Absolute Maximum Ratings

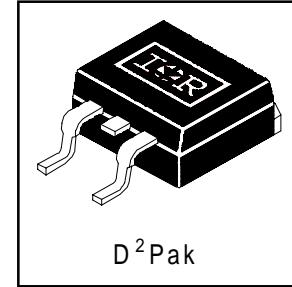
	Parameter	Max.	Units	
V_{CES}	Collector-to-Emitter Voltage	600	V	
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	28	A	
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	16		
I_{CM}	Pulsed Collector Current ①	58		
I_{LM}	Clamped Inductive Load Current ②	58		
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	12	W	
I_{FM}	Diode Maximum Forward Current	58		
t_{sc}	Short Circuit Withstand Time	10		
V_{GE}	Gate-to-Emitter Voltage	± 20		
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	100	$^\circ C$	
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	42		
T_J	Operating Junction and	-55 to +150		
T_{STG}	Storage Temperature Range			
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)		
	Mounting Torque, 6-32 or M3 Screw.	10 lbf-in (1.1 Nm)		

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	1.2	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case - Diode	—	2.5	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.5	—	
$R_{\theta JA}$	Junction-to-Ambient (PCB Mounted,steady-state)⑤	—	40	
Wt	Weight	1.44	—	g



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 2.21V$
 $@ V_{GE} = 15V, I_C = 16A$



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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage ^③	600	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.54	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.21	2.7	V	$I_C = 16\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.88	—		$I_C = 28\text{A}$ See Fig. 2, 5
		—	2.36	—		$I_C = 16\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-12	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ^④	5.4	8.1	—	S	$V_{\text{CE}} = 100\text{V}$, $I_C = 16\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$
		—	—	2500		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$, $T_J = 150^\circ\text{C}$
V_{FM}	Diode Forward Voltage Drop	—	1.4	1.7	V	$I_C = 12\text{A}$ See Fig. 13
		—	1.3	1.6		$I_C = 12\text{A}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	67	100	nC	$I_C = 16\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	11	16		$V_{\text{CC}} = 400\text{V}$ See Fig.8
Q_{gc}	Gate - Collector Charge (turn-on)	—	25	37		$V_{\text{GE}} = 15\text{V}$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	60	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 16\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$ Energy losses include "tail" and diode reverse recovery See Fig. 9,10,14
t_r	Rise Time	—	42	—		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	160	250		
t_f	Fall Time	—	80	120		
E_{on}	Turn-On Switching Loss	—	0.60	—	mJ	$V_{\text{CC}} = 360\text{V}$, $T_J = 125^\circ\text{C}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 10\Omega$, $V_{\text{CPK}} < 500\text{V}$
E_{off}	Turn-Off Switching Loss	—	0.58	—		
E_{ts}	Total Switching Loss	—	1.18	1.6		
t_{sc}	Short Circuit Withstand Time	10	—	—	μs	$T_J = 150^\circ\text{C}$, See Fig. 11,14 $I_C = 16\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 23\Omega$ Energy losses include "tail" and diode reverse recovery
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	58	—		
t_r	Rise Time	—	42	—		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	210	—		
t_f	Fall Time	—	160	—	mJ	Measured 5mm from package
E_{ts}	Total Switching Loss	—	1.69	—		
L_E	Internal Emitter Inductance	—	7.5	—	nH	
C_{ies}	Input Capacitance	—	920	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
C_{oes}	Output Capacitance	—	110	—		
C_{res}	Reverse Transfer Capacitance	—	27	—		
t_{rr}	Diode Reverse Recovery Time	—	42	60	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	80	120		$T_J = 125^\circ\text{C}$ 14
I_{rr}	Diode Peak Reverse Recovery Current	—	3.5	6.0	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	5.6	10		$T_J = 125^\circ\text{C}$ 15
Q_{rr}	Diode Reverse Recovery Charge	—	80	180	nC	$T_J = 25^\circ\text{C}$ See Fig.
		—	220	600		$T_J = 125^\circ\text{C}$ 16
$dI_{(\text{rec})M}/dt$	Diode Peak Rate of Fall of Recovery During t_b	—	180	—	A/ μs	$T_J = 25^\circ\text{C}$ See Fig.
		—	160	—		$T_J = 125^\circ\text{C}$ 17

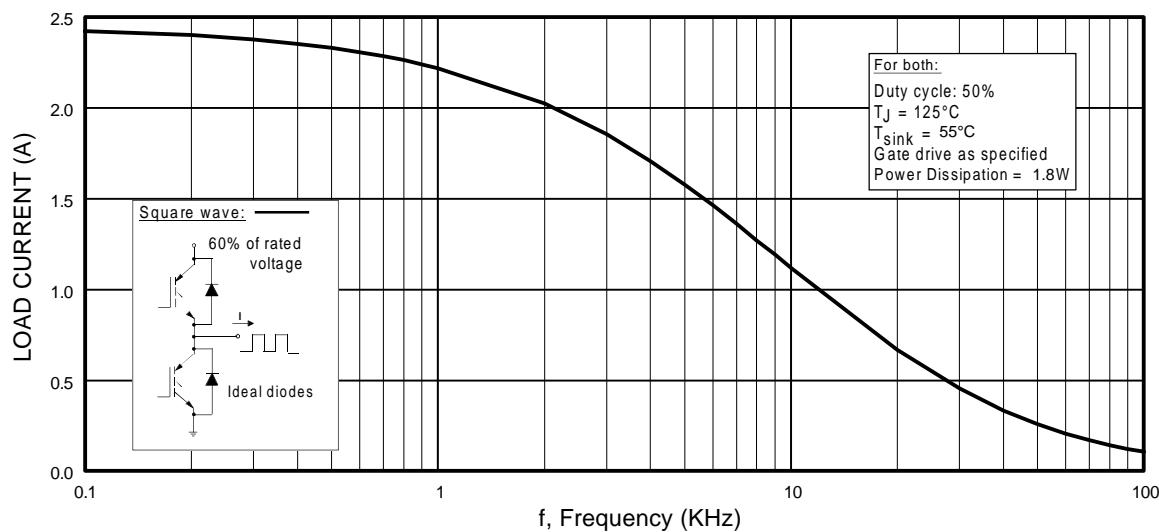


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

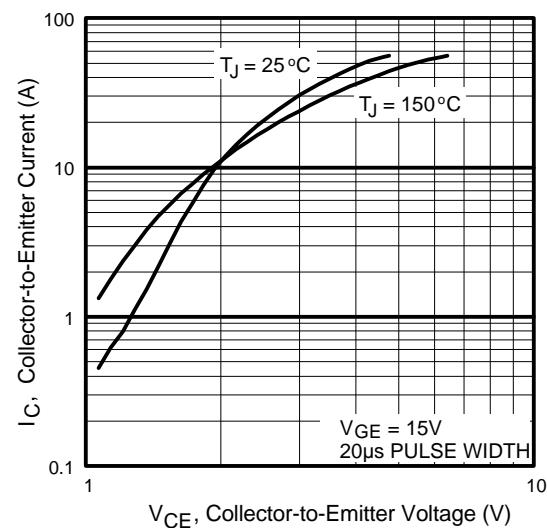


Fig. 2 - Typical Output Characteristics

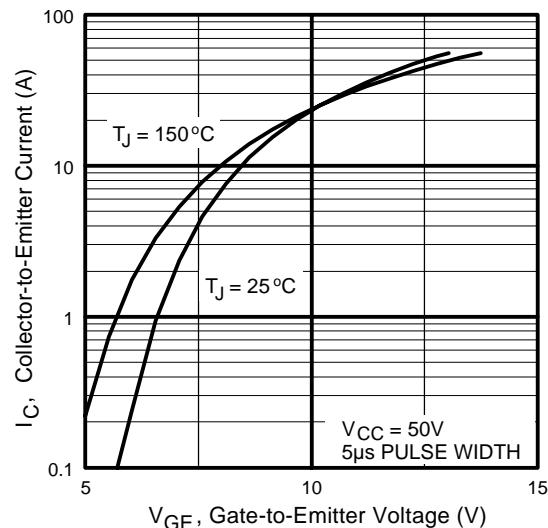


Fig. 3 - Typical Transfer Characteristics

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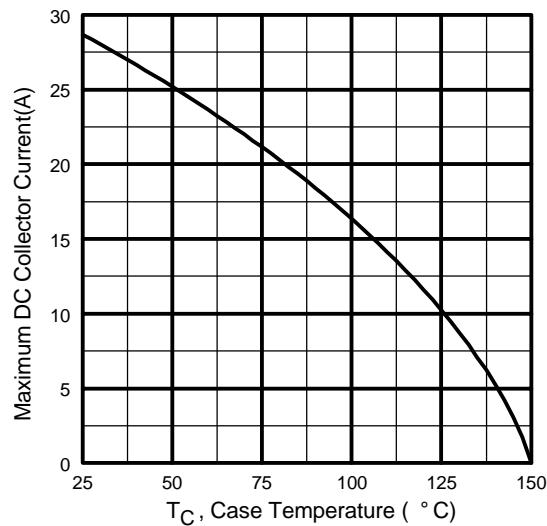


Fig. 4 - Maximum Collector Current vs. Case Temperature

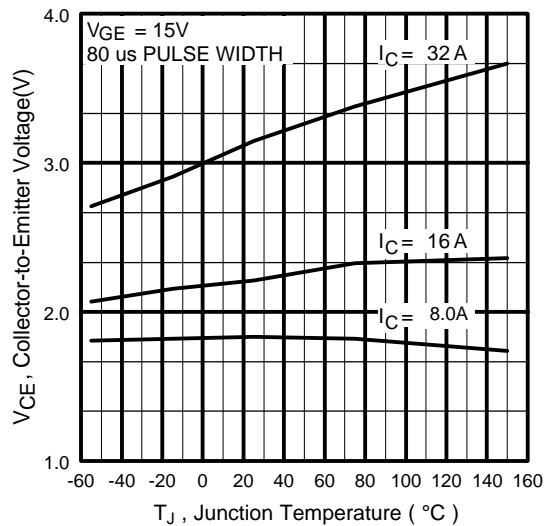


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

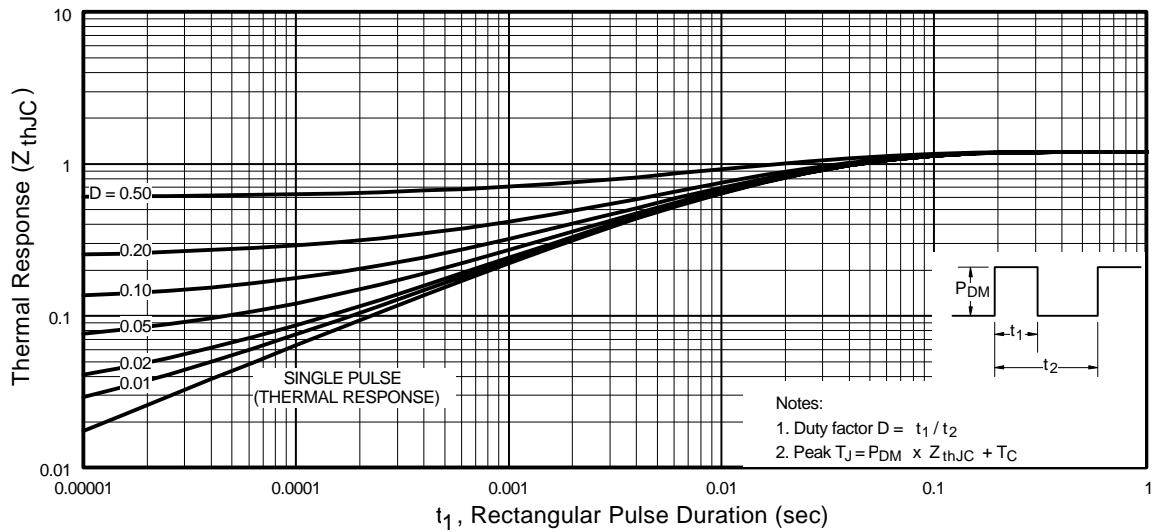


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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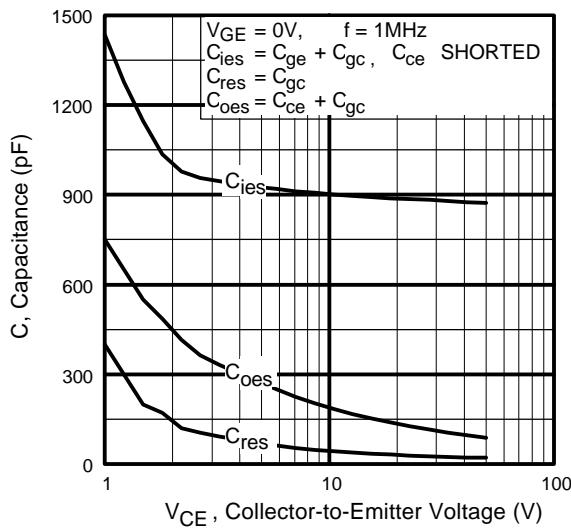


Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage

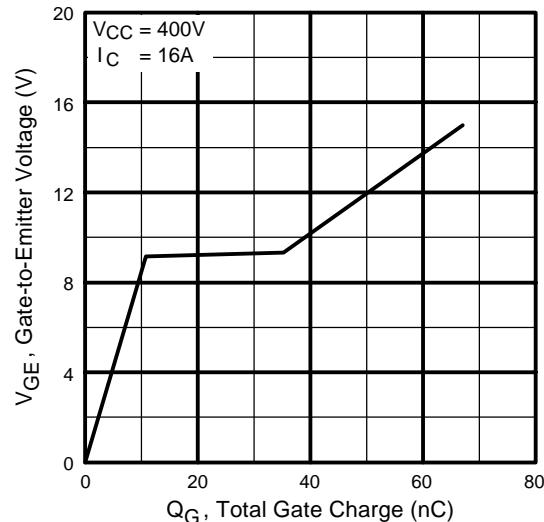


Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage

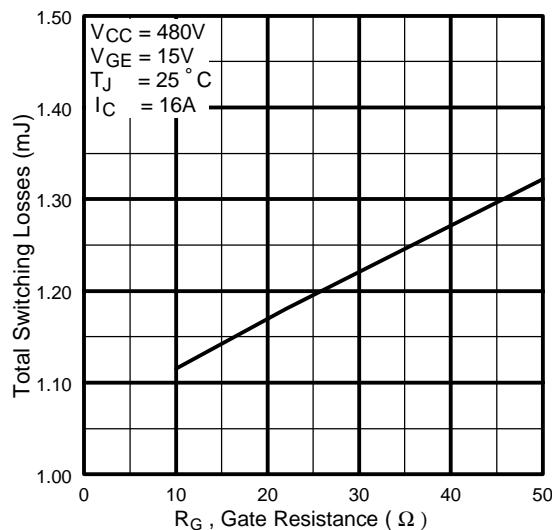


Fig. 9 - Typical Switching Losses vs. Gate
Resistance

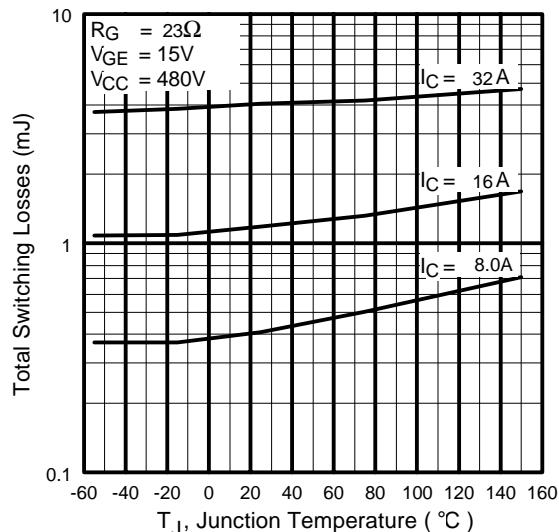
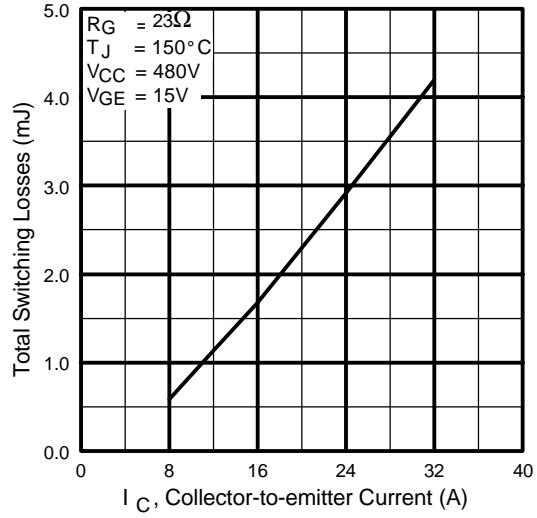


Fig. 10 - Typical Switching Losses vs.
Junction Temperature

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**Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current**

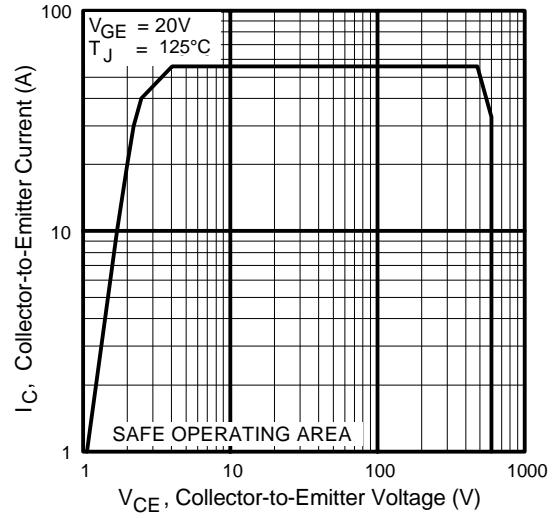


Fig. 12 - Turn-Off SOA

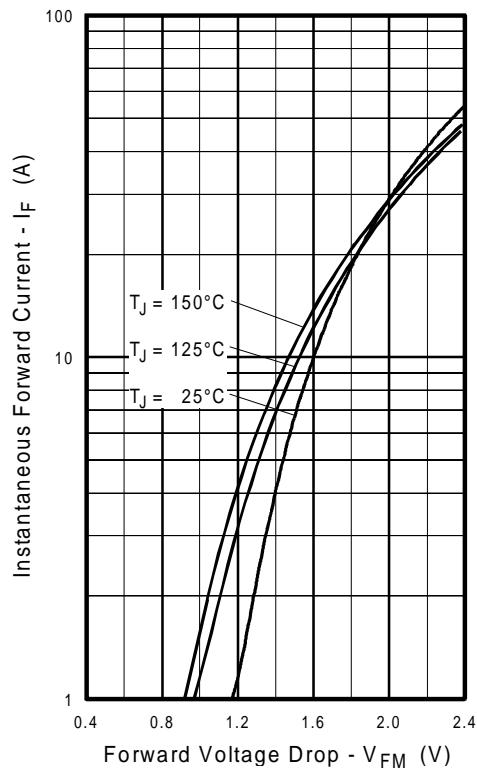


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

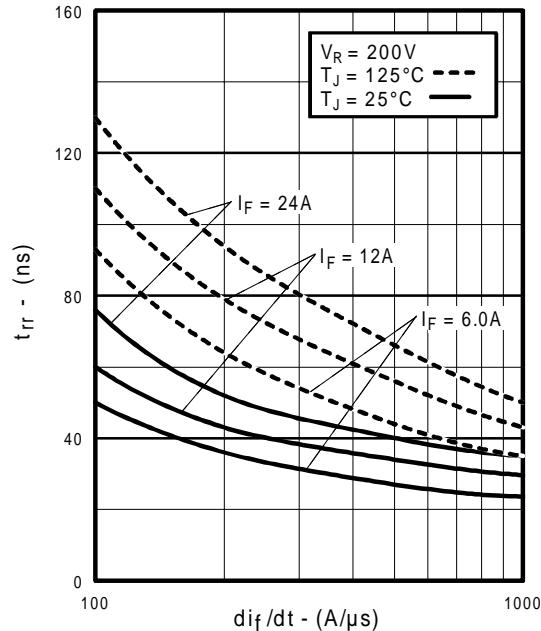


Fig. 14 - Typical Reverse Recovery vs. d_i_f/dt

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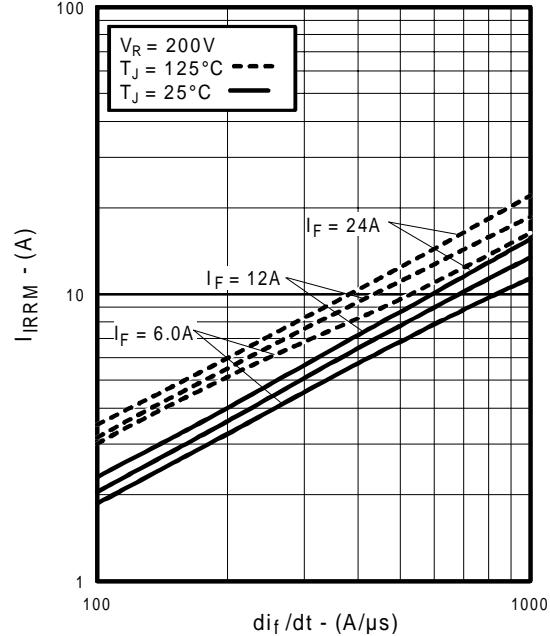


Fig. 15 - Typical Recovery Current vs. d_i_f/dt

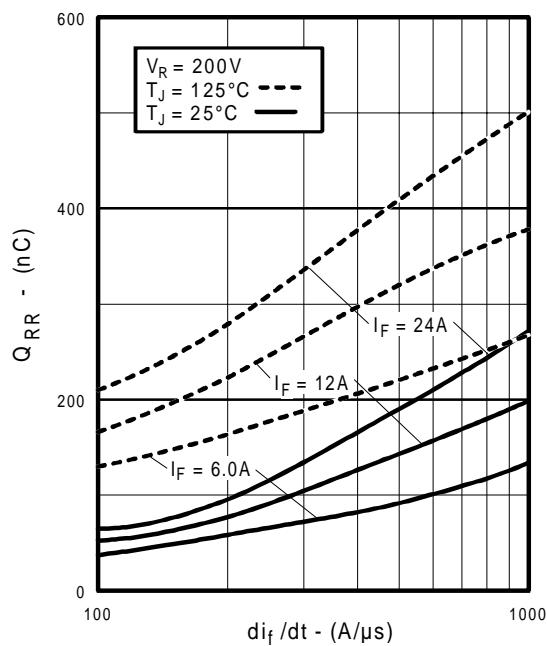


Fig. 16 - Typical Stored Charge vs. d_i_f/dt

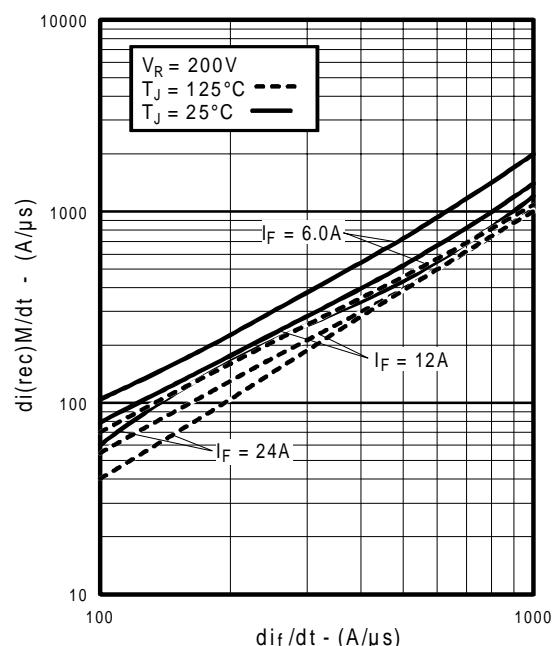


Fig. 17 - Typical $di_{(rec)M}/dt$ vs. d_i_f/dt

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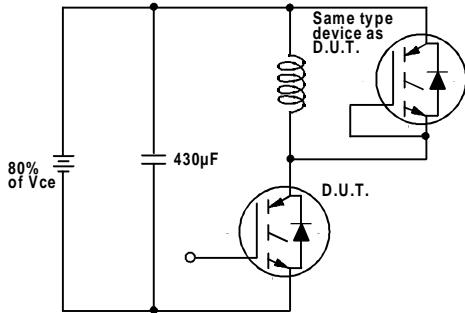


Fig. 18a - Test Circuit for Measurement of
 I_{LM} , E_{on} , $E_{off(diode)}$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

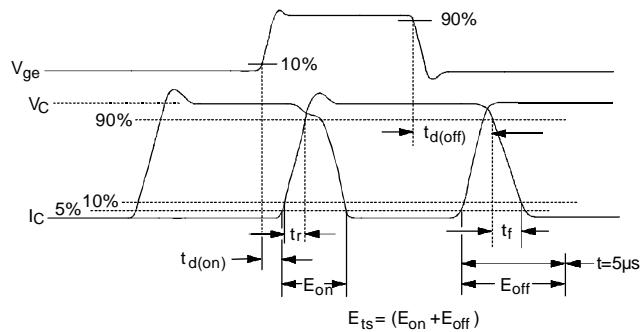


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining
 E_{off} , $t_{d(off)}$, t_f

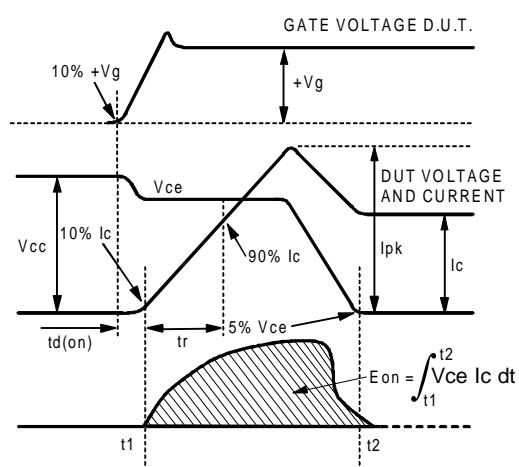


Fig. 18c - Test Waveforms for Circuit of Fig. 18a,
Defining E_{on} , $t_{d(on)}$, t_r

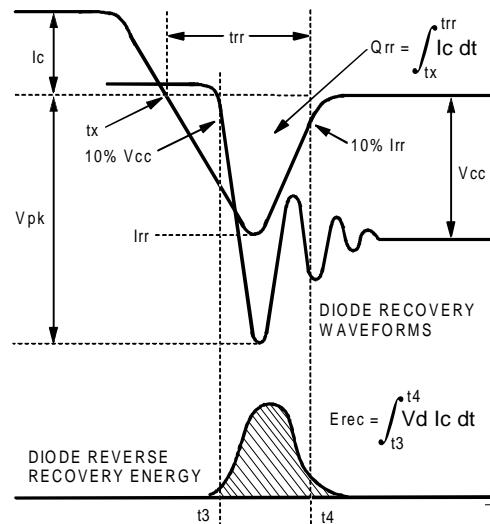


Fig. 18d - Test Waveforms for Circuit of Fig. 18a,
Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

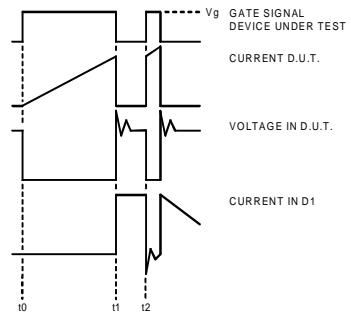


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

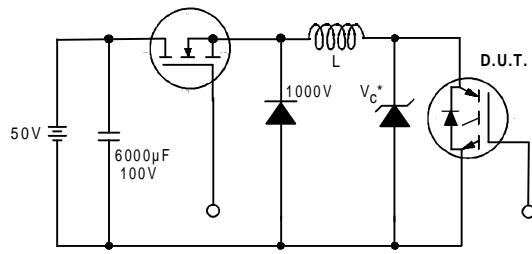


Figure 19. Clamped Inductive Load Test Circuit

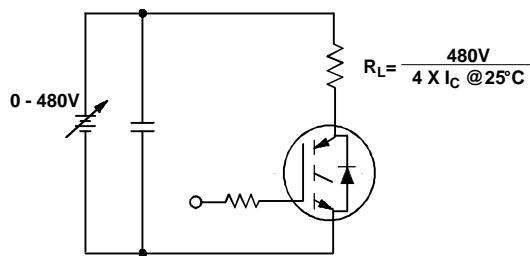
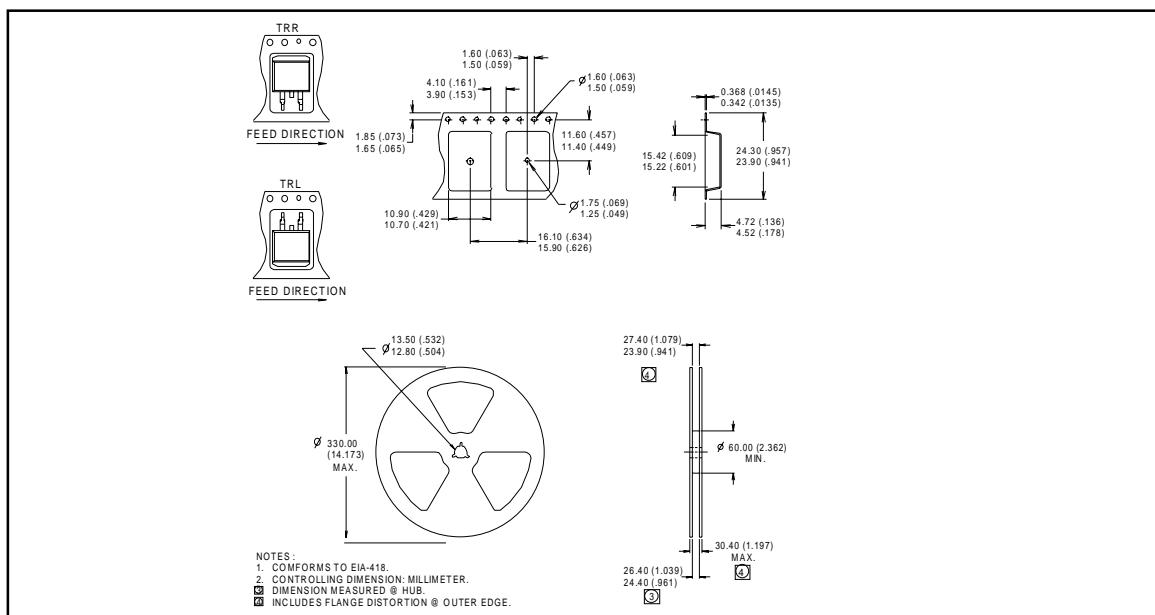


Figure 20. Pulsed Collector Current Test Circuit

Tape & Reel Information

D²Pak



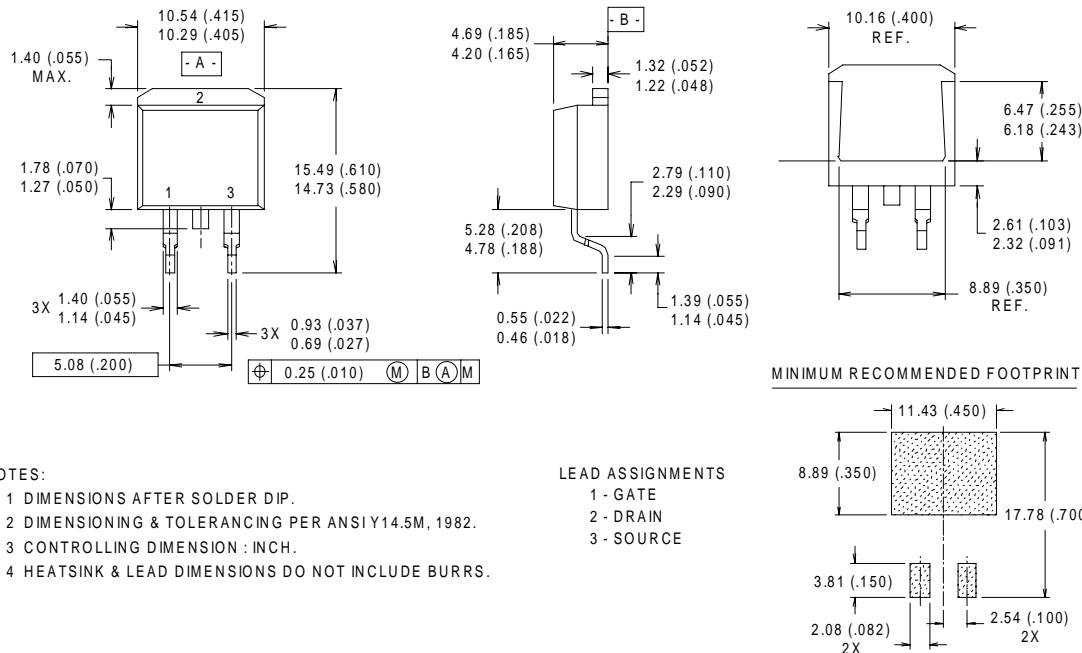
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Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\% (V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G=23\Omega$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ④ Pulse width $5.0\mu s$, single shot.
- ⑤ When mounted on 1" square PCB (FR-4 or G-10 Material).
For recommended footprint and soldering techniques refer to application note #AN-994.

D²Pak Package Outline



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IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
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IR CANADA: 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200

IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 (0) 6172 96590

IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 011 451 0111

IR JAPAN: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo 171 Tel: 81 (0)3 3983 0086

IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 (0)838 4630

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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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